

Switching (60V, 200mA)

RHU002N06

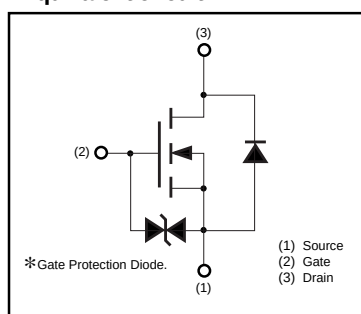
●Features

- 1) Low on-resistance.
- 2) High ESD.
- 3) High-speed switching.
- 4) Low-voltage drive (4V).
- 5) Easily designed drive circuits.
- 6) Easy to use in parallel.

●Structure

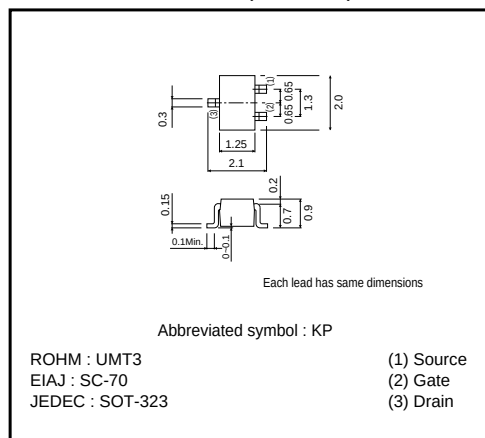
Silicon N-channel
MOSFET transistor

●Equivalent circuit



* A protection diode has been built in between the gate and the source to protect against static electricity when the product is in use.
Use the protection circuit when fixed voltages are exceeded.

●External dimensions (Unit : mm)



●Absolute maximum ratings (Ta=25°C)

Parameter		Symbol	Limits	Unit
Drain-source voltage		V_{DS}	60	V
Gate-source voltage		V_{GS}	± 20	V
Drain current	Continuous	I_D	200	mA
	Pulsed	I_{DP}^{*1}	800	mA
Source current	Continuous	I_S	200	mA
	Pulsed	I_{SP}^{*1}	800	mA
Total power dissipation		P_D^{*2}	200	mW
Channel temperature		T_{ch}	150	°C
Storage temperature		T_{stg}	-55 to +150	°C

*1 $P_w \leq 10 \mu s$, Duty cycle $\leq 1\%$

*2 Each terminal mounted on a recommended

Transistors

●Electrical characteristics (Ta=25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Gate leakage current	I_{GSS}	—	—	± 10	μA	$V_{GS}=\pm 20V, V_{DS}=0V$
Drain-source breakdown voltage	$V_{(BR)DSS}$	60	—	—	V	$I_D=10\mu A, V_{GS}=0V$
Drain cutoff current	I_{DSS}	—	—	1	μA	$V_{DS}=60V, V_{GS}=0V$
Gate threshold voltage	$V_{GS(th)}$	1	—	2.5	V	$V_{DS}=10V, I_D=1mA$
Drain-source on-state resistance	$R_{DS(on)}^{*1}$	—	1.7	2.4	Ω	$I_D=200mA, V_{GS}=10V$
		—	2.8	4.0		$I_D=200mA, V_{GS}=4V$
Forward transfer admittance	$ Y_{fs} ^{*1}$	100	—	—	mS	$V_{DS}=10V, I_D=200mA$
Input capacitance	C_{iss}	—	15	—	pF	$V_{DS}=10V$
Output capacitance	C_{oss}	—	8	—	pF	$V_{GS}=0V$
Reverse transfer capacitance	C_{rss}	—	4	—	pF	$f=1MHz$
Turn-on delay time	$t_{d(on)}^{*2}$	—	6	—	ns	$I_D=100mA, V_{DD}\approx 30V$ $V_{GS}=10V$ $R_L=300\Omega$ $R_{GS}=10\Omega$
Rise time	t_r^{*2}	—	5	—	ns	
Turn-off delay time	$t_{d(off)}^{*2}$	—	12	—	ns	
Fall time	t_f^{*2}	—	95	—	ns	
Total gate charge	Q_g^{*2}	—	2.2	4.4	nC	$V_{DD}\approx 30V$
Gate-source charge	Q_{gs}^{*2}	—	0.6	—	nC	$V_{GS}=10V$
Gate-drain charge	Q_{gd}^{*2}	—	0.3	—	nC	$I_D=200mA$

*1 $P_W \leq 300\mu s$, Duty cycle $\leq 1\%$

*2 Pulsed

●Packaging specifications

Type	Package	Taping
	Code	T106
	Basic ordering unit (pieces)	3000
RHU002N06		○

●Electrical characteristic curves

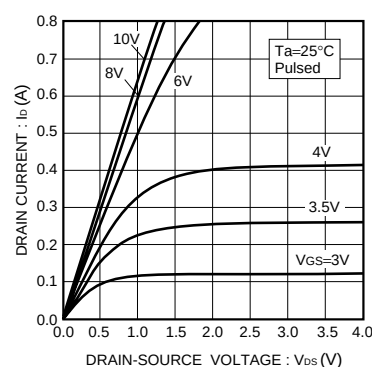


Fig.1 Typical Output Characteristics

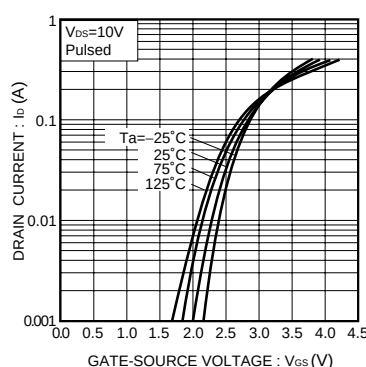


Fig.2 Typical Transfer Characteristics

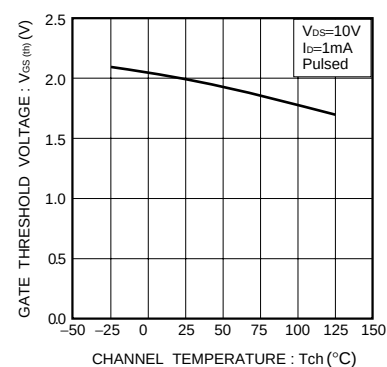


Fig.3 Gate Threshold Voltage vs. Channel Temperature

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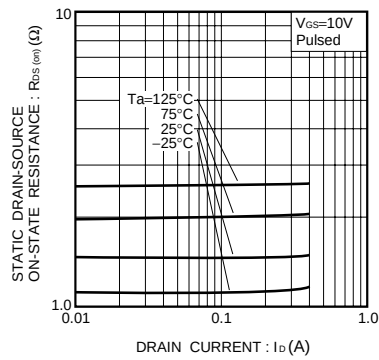


Fig.4 Static Drain-Source On-State Resistance vs. Drain Current (I)

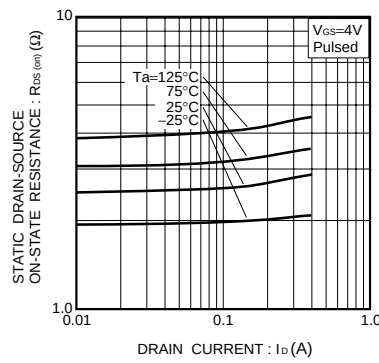


Fig.5 Static Drain-Source On-State Resistance vs. Drain Current (II)

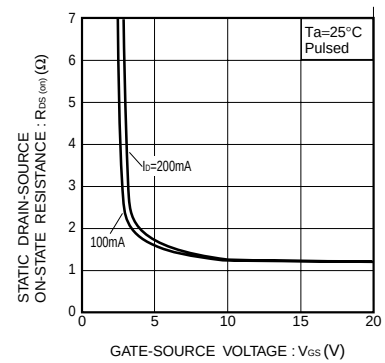


Fig.6 Static Drain-Source On-State Resistance vs. Gate-Source Voltage

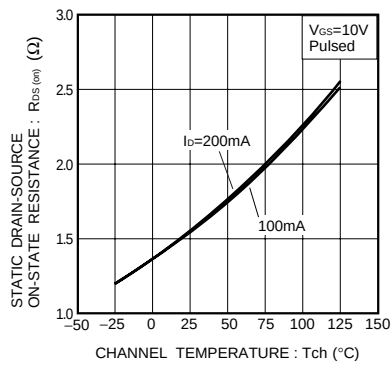


Fig.7 Static Drain-Source On-State Resistance vs. Channel Temperature

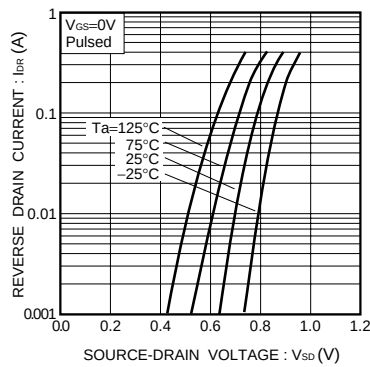


Fig.8 Reverse Drain Current vs. Source-Drain Voltage (I)

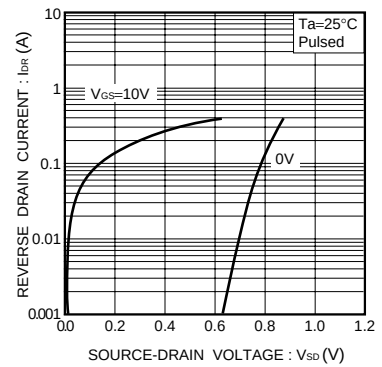


Fig.9 Reverse Drain Current vs. Source-Drain Voltage (II)

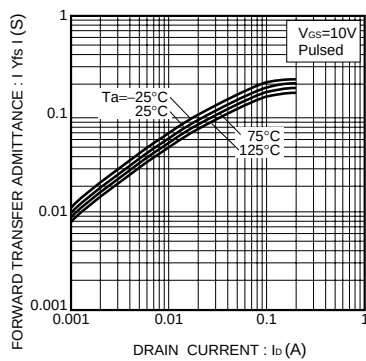


Fig.10 Forward Transfer Admittance vs. Drain Current

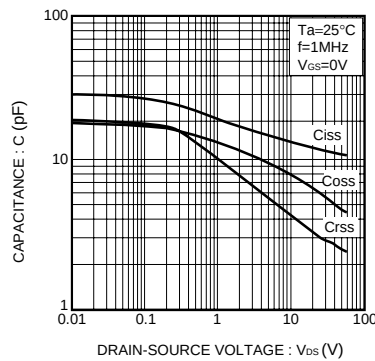


Fig.11 Typical Capacitance vs. Drain-Source Voltage

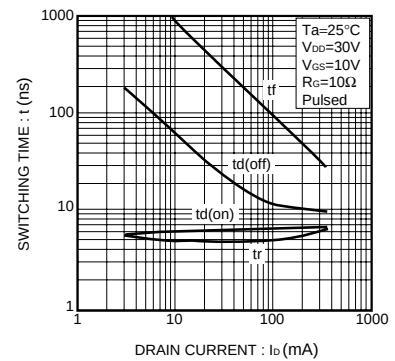


Fig.12 Switching Characteristics

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● Switching characteristics measurement circuit

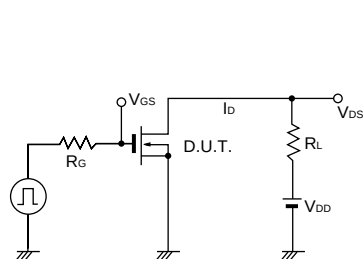


Fig.13 Switching time test circuit

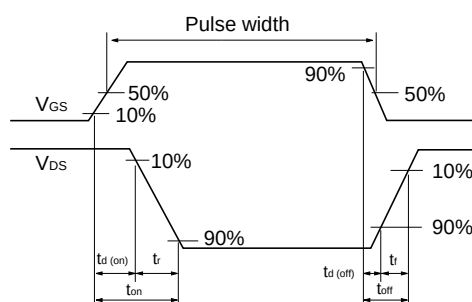


Fig.14 Switching time waveforms

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